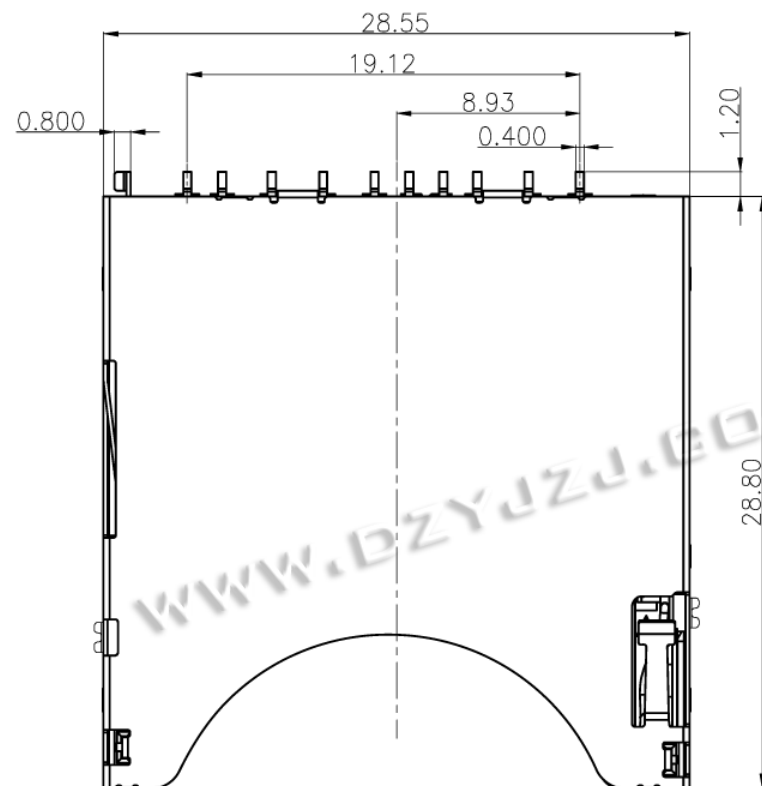


MATERIAL: Specification

Insulator: High Temperature Thermoplastic,
UL 94V-0.

Contact: Copper Alloy
Shell: Stainless Steel

PLATING:

Contact: Plated 50u" Ni Overall
Plated Au Selective Contact Area
Plated 100u" Sn Over Ni On Solder Area
Shell: Plated 50u" Ni Overall
Plated 1u" Au Over Ni On Solder Area

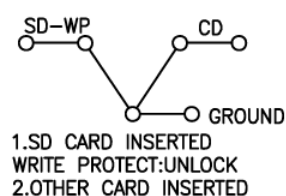
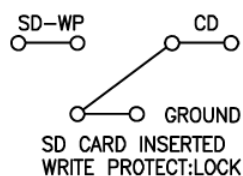
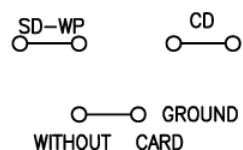
Property:

Current Rating :0.5A AC/DC max.
Voltage Rating :125V AC/DC
Ambient Temperature Range :-30°C~+85°C
Ambient Humidity Range :95% R.H. Max.
Contact Resistance:100mΩ max.
Insulation Resistance:1000MΩ min./500VDC
Durability:5,000 cycles

Usable Memory Card:

SD&MMC Card

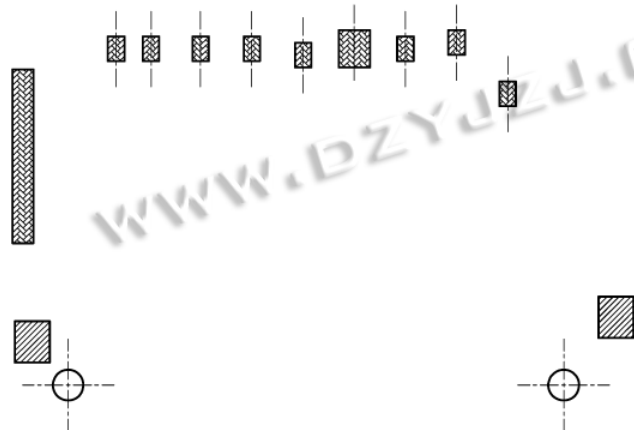
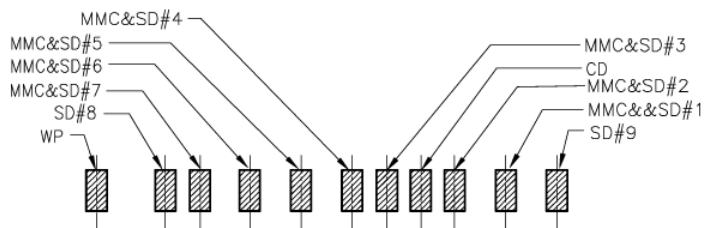
CIRCUIT:



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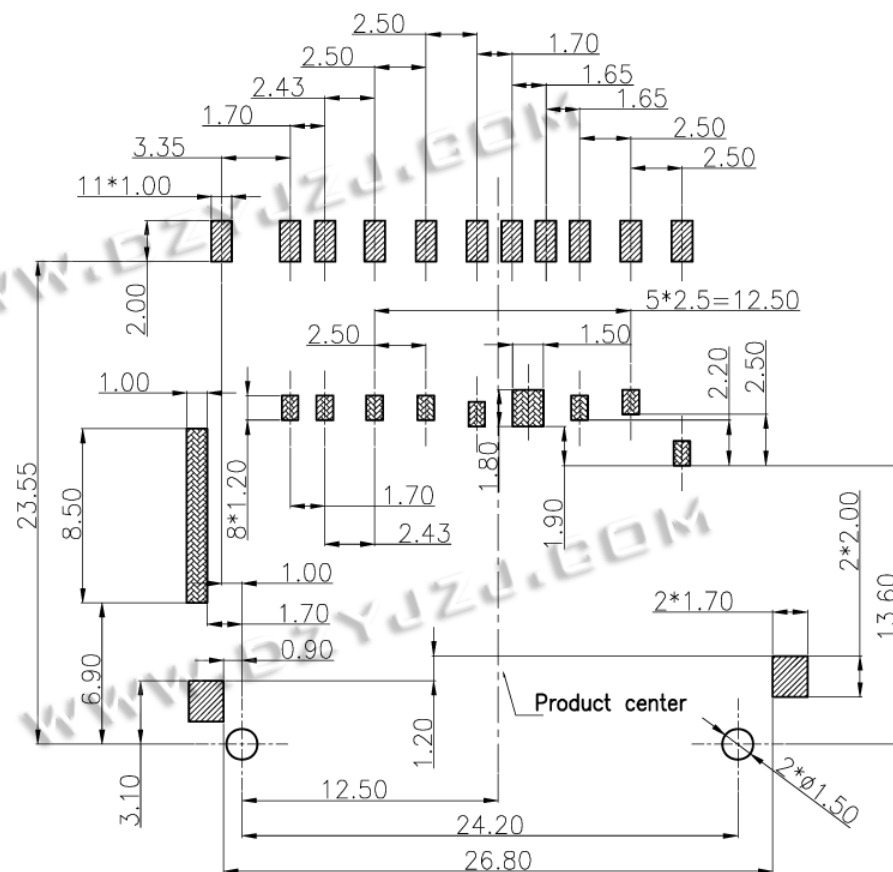
TOLERANCE: X.X ±0.30 X.XX ±0.25 X.XXX ±0.15 X' ±2" X.X' ±0.5"	DRAWN BY : 陈一鸣	DATE : 2014-02-23	PART NAME: SD PUSH 外焊
	CHECKED BY: 马跃	DATE : 2014-02-23	PART NO. HYC30-SD11-288
UNIT: mm [inch] SCALE:1:1 SIZE: A4	APPROVED BY: 邱国夷	DATE : 2014-02-23	DRAW NO: HYC-SD1235201
			SHEET NO. 1 OF 5

PIN ASSIGNMENT:



PIN NO.	MEMORY CARD PIN NO.
MMC&SD#1	MMC&SD#1 (CD/DAT3)
MMC&SD#2	MMC&SD#2 (CMD)
MMC&SD#3	MMC&SD#3 (VSS1)
MMC&SD#4	MMC&SD#4 (VDD)
MMC&SD#5	MMC&SD#5 (CLK)
MMC&SD#6	MMC&SD#6 (VSS2)
MMC&SD#7	MMC&SD#7 (DAT0)
SD#8	SD-8 (DAT1)
SD#9	SD-9 (DAT2)

Recommend PCB Layout Drawing:

(Unit:mm .X $\pm$ 0.15 .XX $\pm$ 0.05 .XXX $\pm$ 0.02)

Welding area



prohibited layout area



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TOLERANCE:
X.X $\pm$ 0.30
X.XX $\pm$ 0.25
X.XXX $\pm$ 0.15
X.' $\pm$ 2" X.X' $\pm$ 0.5"



UNIT: mm [inch]

SCALE:1:1 SIZE: A4

DRAWN BY :
陈一鸣

DATE :
2014-02-23

PART NAME:
SD PUSH 外焊

CHECKED BY:
马跃

DATE :
2014-02-23

PART NO. HYC30-SD11-288

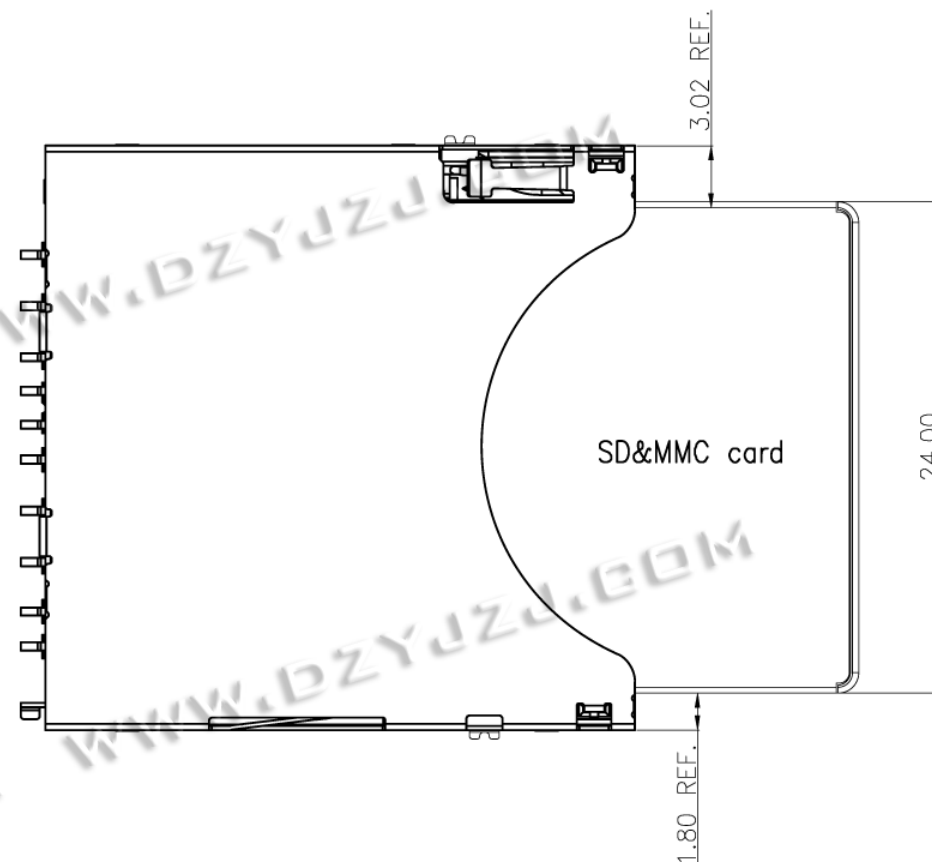
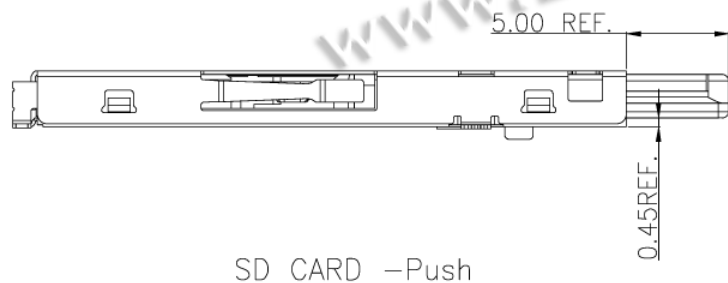
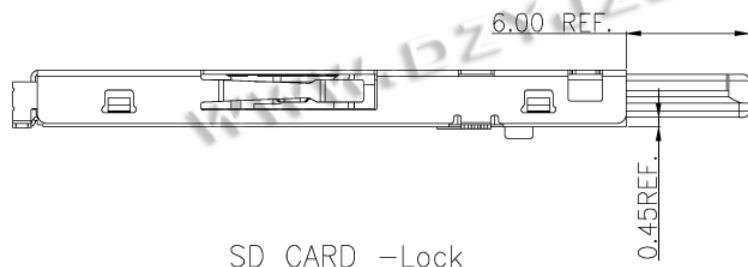
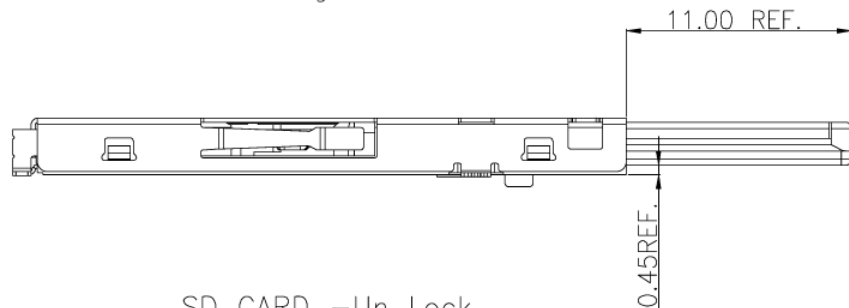
APPROVED BY:
邱国夷

DATE :
2014-02-23

DRAW NO: HYC-SD1235201

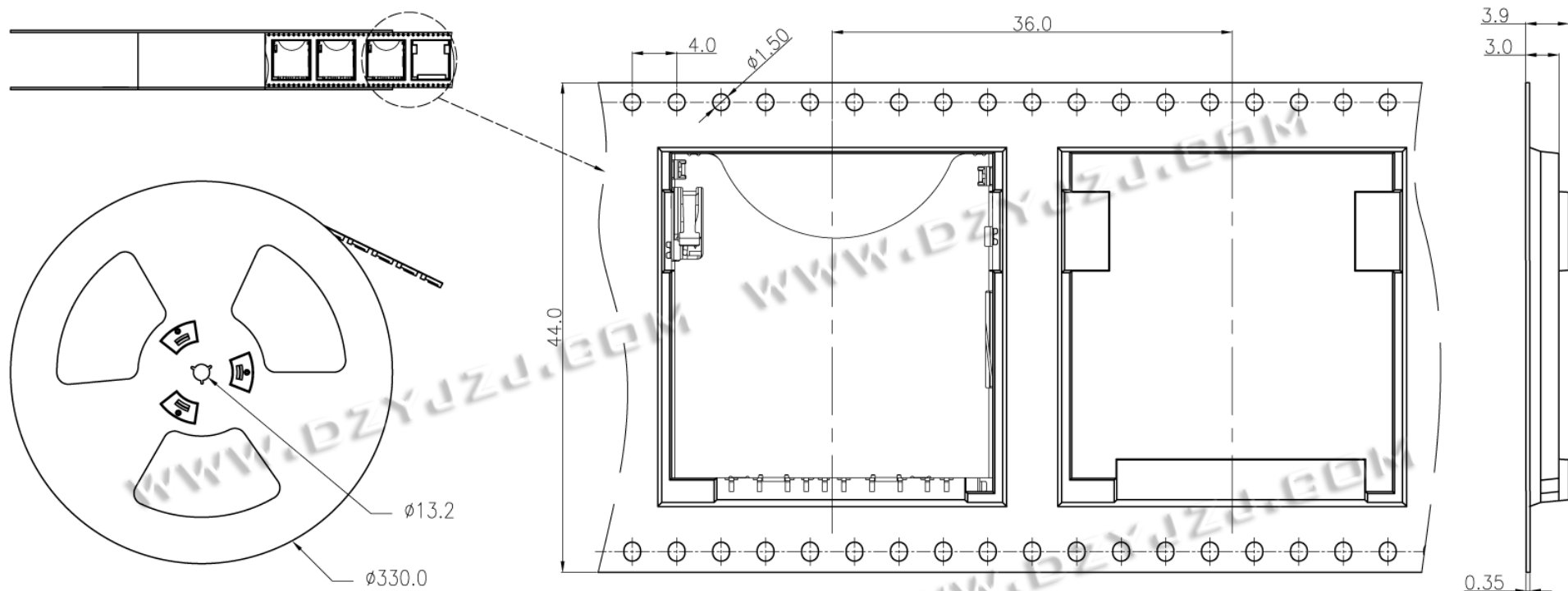
SHEET NO. 2 OF 5

SD Card Insert Drawing:



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TOLERANCE: X.X ±0.30 X.XX ±0.25 X.XXX ±0.15 X." ±2" X." ±0.5"	DRAWN BY : 陈一鸣	DATE : 2014-02-23	PART NAME: SD PUSH 外焊	
	CHECKED BY: 马跃	DATE : 2014-02-23	PART NO. HYC30-SD11-288	MOLD NO.
 UNIT: mm [inch] SCALE: 1:1 SIZE: A4	APPROVED BY: 邱国夷	DATE : 2014-02-23	DRAW NO: HYC-SD1235201	SHEET NO. 3 OF 5



注意 (Note):

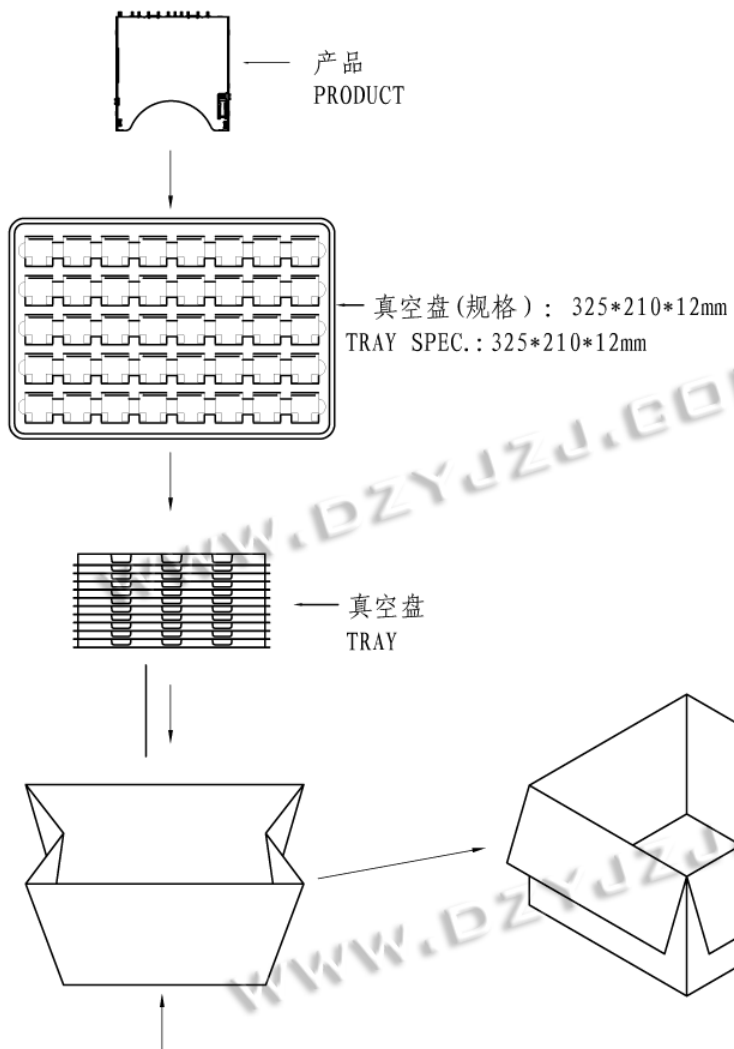
1. 将产品一一放入卷带内, 依同一方向摆放 (PUT PRODUCT INTO THE TAPE REEL, AND AS SAME DIRECTION)
2. 产品放置时, 如图所示 (THE DIRECTION REFERS TO DRAWING)
3. 每个卷盘装入400pcs 产品 (QUANTITY OF PER TAPE REEL: 400 PCS)
4. 一个纸箱可放入5个卷盘 (QUANTITY OF PER CARTON: 5 TAPE REEL)
5. 一个纸箱可装入2000 PCS 产品 (QUANTITY OF PER CARTON: 2000 PCS)
6. 若有未装满之尾数箱, 必须用缓冲材加满 (THE UNFILLING-CARTON MUST BE FILLED WITH ASSUAGEMENT)
7. 装满产品之纸箱, 最大堆积数量为5箱 (THE CARTON FULLY FILLED WITH PRODUCTS, THE MAX. ACCUMULATING QUANTITY IS 5 CARTONS)
8. 产品单重为: 2.04g; 每箱单重为: 9.8kg/箱 (THE WEIGHT OF PER PRODUCT: 2.04g; PER CARTON: 9.8kg)



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TOLERANCE: X.X ±0.30 X.XX ±0.25 X.XXX ±0.15 X' ±2" X.X' ±0.5" UNIT: mm [inch] SCALE:1:1 SIZE: A4	DRAWN BY : 陈一鸣	DATE : 2014-02-23	PART NAME: 包装图	
	CHECKED BY: 马跃	DATE : 2014-02-23	PART NO.	
	APPROVED BY: 邱国夷	DATE : 2014-02-23	MOLD NO.	
			DRAW NO:	
			SHEET NO.	1 OF 1

THE PACKING FOR SD CARD SERIES PUSH TYPE



1. 将产品一一放入真空盒内, 依同一方向摆放
PUT PRODUCT INTO THE TRAY, AND AS SAME DIRECTION
2. 产品放置时, 如图所示
THE DIRECTION REFERS TO DRAWING
3. 每个真空盘装入40pcs 产品
QUANTITY OF PER TRAY: 40 PCS
4. 一个纸箱可放入31个真空盘
QUANTITY OF PER CARTON: 31 TRAYS
5. 最上面一个真空盘用作上盖, 不装入产品
THE TOP TRAY NOT PUT INTO PRODUCT
AS A COVER TO PROTECT PRODUCT
5. 一个纸箱可装入1,200 PCS产品
QUANTITY OF PER CARTON: 1,200 PCS
6. 若有未装满之尾数箱, 必须用缓冲材加满
THE UNFILLING-CARTON MUST BE FILLED WITH ASSUAGEMENT
7. 装满产品之纸箱, 最大堆积数量为5箱
THE CARTON FULLY FILLED WITH PRODUCTS
THE MAX. ACCUMULATING QUANTITY IS 5 CARTONS
8. 产品单重为: 2.04g; 每箱单重为: 4.35kg/箱
THE WEIGHT OF PER PRODUCT: 2.04g; PER CARTON: 4.35Kg



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TOLERANCE: X.X ±0.30 X.XX ±0.25 X.XXX ±0.15 X.' ±2" X.X' ±0.5'	DRAWN BY : 陈一鸣	DATE : 2014-02-23	PART NAME: 包装图	
	CHECKED BY: 马跃	DATE : 2014-02-23	PART NO.	
 UNIT: mm [inch] SCALE:1:1 SIZE: A4	APPROVED BY: 邱国夷	DATE : 2014-02-23	MOLD NO.	
			DRAW NO:	
			SHEET NO.	1 OF 1